

ALPHA® ROSIN FLUX 800 (RF-800)

NO CLEAN FLUX

DESCRIPTION

ALPHA RF-800 provides the broadest process window for a no-clean flux with less than 5% solids content. **ALPHA RF-800** is designed to provide excellent soldering results (low defects rates), even when the surfaces to be soldered (component leads and pads) are not highly solderable. **ALPHA RF-800** works particularly well with bare copper boards protected with organic or rosin/resin coatings and with tin-lead coated PCB's. **ALPHA RF-800** is used successfully in both tin-lead and lead-free applications.

ALPHA RF-800 is a very active, low solid, no-clean flux. It is formulated with a proprietary activator system. A small percentage of rosin is added for enhanced thermal stability. The activators are designed to provide the broadest operating window for a low solid, no-clean flux, while maintaining a high level of long-term electrical reliability. After wave soldering, **ALPHA RF-800** leaves a low level of non-tacky residue, which is easily penetrable in pin testing.

FEATURES & BENEFITS

- Highly active for excellent soldering and low defect rates.
- Low level of non-tacky residue to reduce interference with pin testing.
- Cleaning is not required which reduces operating costs.
- Reduces the surface tension between solder mask & solder to significantly reduce solder ball frequency.
- Meets Bellcore requirements for long-term electrical reliability.

APPLICATION GUIDELINES

PREPARATION - In order to maintain consistent soldering performance and electrical reliability, it is important to begin the process with circuit boards and components that meet established requirements for solderability and ionic cleanliness. It is suggested that assemblers establish specifications on these items with their suppliers and that suppliers provide Certificates of Analysis with shipments and/or assemblers perform incoming inspection. A common specification for the ionic cleanliness of incoming boards and components is 5µg/in² maximum, as measured by an Omegameter with heated solution.

Care should be taken in handling the circuit boards throughout the process. Boards should always be held at the edges. The use of clean, lint-free gloves is also recommended. When switching from one flux to another, the use of a new foam stone is recommended (for foam fluxing).

Conveyors, fingers and pallets should be cleaned. **ALPHA SM-110** Solvent Cleaner has been found to be very useful for these cleaning applications. When foam fluxing, do not use hot fixtures or pallets. Hot fixtures/pallets will deteriorate the foam head.

FLUX APPLICATION – **ALPHA RF-800** is formulated to be applied by foam, wave or spray methods. When foam fluxing, the foam fluxer should be supplied with compressed air which is free of oil and water.

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Keep the flux tank full at all times. The flux level should be maintained 1 inch to 1-½ inches above the top of the stone. Adjust the air pressure to produce the optimum foam height with a fine, uniform foam head.

A uniform coating of flux is essential to successful soldering. When using the foam or wave method of application, an air knife is recommended after the fluxing operation. An air knife will help ensure that the flux is uniformly distributed across the board and will remove the excess flux. When spray fluxing, the uniformity of the coating can be visually checked by running a piece of cardboard over the spray fluxer or by processing a board-sized piece of tempered glass through the spray and then through the preheat section.

OPERATING PARAMETER	SAC305/SACX0307	63Sn/37Pb
Amount of Flux Applied	Single Wave: 1000-1200 µg/in ² of solids Dual Wave: 1100-1500 µg/in ² of solids	Foam: 1,000 - 2,000 µg/in ² of solids Spray: 750 - 1,500 µg/in ² of solids
When foam fluxing		
Foam Stone Pore Size	20 -50 µm	20 -50 µm
Distance that top of stone is submerged below	1 - 1½ inches (25 - 40 mm)	1 - 1½ inches (25 - 40 mm)
Foam Fluxer Chimney Opening	3/8 - 1/2 inch (10-13 mm)	3/8 - 1/2 inch (10-13 mm)
When foam fluxing, use an Air Knife		
Air Knife Hole Diameter	1 - 1.5 mm	1 - 1.5
Distance Between Holes	4 - 5 mm	4 - 5
Distance from Fluxer to Air Knife	4 - 6 inches (10-15 cm)	4 - 6 inches (10-15 cm)
Air Knife Angle Back toward Fluxer from Perpendicular	3° - 5°	3° - 5°
Topside Preheat Temperature	190° - 247°F (85° - 120°C)	190°F – 230°F (85°C - 110°C)
Bottomside Preheat Temperature	about 65°F (35°C) higher than topside	about 65°F (35°C) higher than topside
Maximum Ramp Rate of Topside Temperature (to avoid component damage)	2°C/second (3.5°F/second) maximum	2°C/second (3.5°F/second) maximum
Conveyor Angle	5°-8° (6° most common)	5°-8° (6° most common)
Conveyor Speed	3 – 6 feet/minute (.9 – 1.8 meters/minute)	4 - 6 feet/minute (1.2 - 1.8 meters/minute)
Contact Time in the Solder (includes ChipWave and Primary)	1.5 - 3.5 seconds (2-2½ seconds most common)	1.5 - 3.5 seconds (2-2½ seconds most common)
Solder Pot Temperature	490° - 520°F (250° - 270°C)	460° – 500°F (235°-260°C)
These are general guidelines which have proven to yield excellent results; however, depending upon your equipment, components, and circuit boards, your optimal settings may be different. In order to optimize your process, it is recommended to perform a designed experiment, optimizing the most important variables (amount of flux applied, conveyor speed, preheat temperatures, and solder pot temperature and board orientation).		

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FLUX SOLIDS CONTROL - If foam, wave, or rotary drum, spray fluxing, the flux solids will need to be controlled via thinner addition to replace evaporative losses of the flux solvent. As with any flux with less than 5% solids content, specific gravity is not an effective measurement for assessing and controlling the solids content. Monitoring and controlling the acid number is recommended for maintaining the solids content. The acid number should be controlled to between 17 and 19. Alpha's Flux Solids Control Kit #3, a digital titrator, is suggested. Request Alpha's Technical Bulletin SM-458 for details on the kit and titration procedure. When operating the foam fluxer continuously, the acid number should be checked every two to four hours. Over time, debris and contaminants will accumulate in recirculating type flux applicators. For consistent soldering performance, dispose of spent flux every 40 hours of operation. After emptying the flux, the reservoir and foam stone should be thoroughly cleaned with flux thinner.

RESIDUE REMOVAL – ALPHA RF-800 is a no-clean flux and the residues are designed to be left on the board. However, if desired, ALPHA RF-800 residues can be removed with ALPHA 2110 Saponifier.

TOUCH-UP/REWORK - Use of the Cleanline Write Flux Applicator with ALPHA NR205 flux and ALPHA Telecore Series cored solder wire is recommended for hand soldering applications.

SAFETY

Consult the SDS for all safety information. The most recent version of the SDS is available from alphaassembly.com. Inhalation of the flux solvent and volatilized activator fumes which are generated at soldering temperatures may cause headaches, dizziness and nausea. Suitable fume extraction equipment should be used to remove the flux from the work area. An exhaust at the exit end of the wave solder machine may also be needed to completely capture the fumes. Observe precautions during handling and use. Suitable protective clothing should be worn to prevent the material from coming in contact with skin and eyes.

ALPHA RF-800 flux contains a highly flammable solvent with a flashpoint of 56°F (13°C). The flux must not be used near open flames or near non-flameproof electrical equipment.

STORAGE

ALPHA RF-800 should be stored from (10°- 25°C) / (50°-77°F). Shelf life of ALPHA RF-800 is 18 months from date of manufacture when stored as recommended.

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TECHNICAL DATA

Parameters	Typical Values	Parameters/Test Method	Typical Values
Appearance	Pale, yellow liquid	pH (5% aqueous solution)	3.4
Solids Content, wt/wt	3.6	Recommended Thinner	Alpha 425
Acid Number (mg KOH/g)	18 ± 1	Shelf Life (from Date of Mfg.)	540 days
Specific Gravity @ 25°C (77°F)	0.794 ± 0.003	Container Size Availability	1, 5, and 55 Gal.
Pounds Per Gallon	6.6	Bellcore TR-NWT-000078, Issue 3 Compliant	Yes
Flash Point (T.C.C.)	56°F (13°C)	IPC J-STD-004 Designation	ROLO

CORROSION & ELECTRICAL TESTING – SAC305 ALLOY

CORROSION TESTING

Corrosion Testing	Requirement	Results
Silver Chromate Paper Test	No Detection of Halide	PASS
Copper Mirror Test	No Complete Removal of Copper	PASS
IPC Copper Corrosion Test	No evidence of corrosion	No Corrosion (Type L)

IPC J-STD-004A SURFACE INSULATION RESISTANCE

Test	Conditions	Requirements	Results
"Comb-Down" Un-cleaned	85°C/85% RH, 7 days	> 1.0 x 10 ⁸ Ω	1.1 x 10 ¹⁰ Ω
"Comb-Up" Un-cleaned	85°C/85% RH, 7 days	> 1.0 x 10 ⁸ Ω	9.8 x 10 ⁹ Ω
Control Boards	85°C/85% RH, 7 days	> 1.0 x 10 ⁹ Ω	1.1 x 10 ¹⁰ Ω
IPC Test Condition (per J-STD-004A): -50V, measurement @ 100V/IPC B-24 board (0.4 mm lines, 0.5 mm			

IPC J-STD-004B SURFACE INSULATION RESISTANCE

Test	Requirements ($< 1.0 \times 10^8$ allowed during initial 24 hrs.)	Results (min. of all measurements recorded)		
		< 24 Hrs	24 – 168 Hrs	Visual
"Comb-Down" Un-cleaned	> 1.0 x 10 ⁸ Ω	4.1 x 10 ⁹ Ω	4.4 x 10 ⁹ Ω	PASS
"Comb-Up" Un-cleaned	> 1.0 x 10 ⁸ Ω	8.0 x 10 ¹⁰ Ω	9.1 x 10 ¹⁰ Ω	PASS
Control Boards	> 1.0 x 10 ⁹ Ω	9.1 x 10 ¹⁰ Ω	1.3 x 10 ¹¹ Ω	NA
IPC Test Condition (per J-STD-004B TM2.6.3.7): IPC B-24 coupons, 12V, 40°C, 90% RH, measurements recorded @ 20min intervals				

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BELLCORE SURFACE INSULATION RESISTANCE

Test	Conditions	Requirements	Results
"Comb-Down" Un-cleaned	35°C/85% RH, 4 days	> 1.0 x 10 ¹¹ Ω	7.0 x 10 ¹³ Ω
"Comb-Up" Un-cleaned	35°C/85% RH, 4 days	> 1.0 x 10 ¹¹ Ω	4.6 x 10 ¹³ Ω
Control Boards	35°C/85% RH, 4 days	> 2.0 x 10 ¹¹ Ω	3.1 x 10 ¹³ Ω
Bellcore Test Condition (per TR-NWT-000078, Issue 3: 48 Volts, measurement @ 100V/25 mil lines/50 mil spacing.			

BELLCORE ELECTROCHEMICAL MIGRATION RESISTANCE

Test	SIR (Initial)	SIR (Final)	Requirement	Result	Visual Result
"Comb-Up" Un-cleaned	3.0 x 10 ⁹	3.8 x 10 ⁹	SIR (Initial)/SIR (Final) < 10	PASS	PASS
"Comb-Down" Un-cleaned	2.8 x 10 ⁹	4.0 x 10 ⁹	SIR (Initial)/SIR (Final) < 10	PASS	PASS
Bellcore Test Condition (per TR-NWT-000078, Issue 3): 85°C/85%RH/500 Hours/10V, measurement @ 100V/IPC B-25 B Pattern (12.5 mil lines, 12.5 mil spacing)					

CONTACT INFORMATION

To confirm this is the most recent issue, please contact Alpha Assembly Solutions

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Also read carefully warning and safety information on the Safety Data Sheet. This data sheet contains technical information required for safe and economical operation of this product. READ IT THOROUGHLY PRIOR TO PRODUCT USE. Emergency directory assistance Chemtrec 1 - 800 - 424 - 9300.

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